

Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

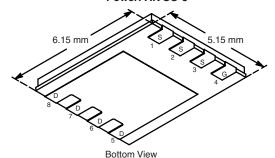
PRODU	JCT SUMMARY		
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)
- 20	0.0019 at V _{GS} = - 10 V	- 60 ^d	128 nC
	0.0030 at V _{GS} = - 4.5 V	- 60 ^d	120 110

• Halogen-fre

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_a Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

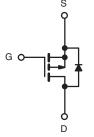


PowerPAK SO-8



APPLICATIONS

- Adaptor Switch
- · Battery Switch
- · Load Switch



Ordering Information: Si7141DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	V
Gate-Source Voltage		V _{GS}	± 20	
	T _C = 25 °C		- 60 ^d	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I-	- 60 ^d	
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	l _D	- 42.7 ^b	
	T _A = 70 °C		- 34 ^b	Α .
Pulsed Drain Current		I _{DM}	- 100	A
Continuous Source-Drain Diode Current	T _C = 25 °C	la la	- 60 ^d	
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S	- 5.6 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 40	
Single-Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	80	mJ
	T _C = 25 °C		104	
Maximum Dawar Dissination	T _C = 70 °C	P _D	66.6	w
Maximum Power Dissipation	T _A = 25 °C	LD	6.25 ^{a, b}	VV
	T _A = 70 °C		4.0 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperature) ^{e, f}			260	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	15	20	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.9	1.2	C/ VV

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 54 °C/W.
- d. Package limited.
- e. See Solder Profile (www.vishay.com/doc273257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

Si7141DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 16		m\//0C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.7		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 2.3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	lana	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	
zero Gate voltage Diain Gunent	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 40			Α
Dunin Course On Chata Basistanas	B	$V_{GS} = -10 \text{ V}, I_D = -25 \text{ A}$		0.0015	0.0019	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.0024	0.0030	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 25 A		103		S
Dynamic ^b						
Input Capacitance	C _{iss}			14 300		
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		2300		pF
Reverse Transfer Capacitance	C _{rss}			2600		
Total Cata Chargo	0	$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -20 \text{ A}$		265	400	nC
Total Gate Charge	Q_g			128	194	
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$		36		IIC
Gate-Drain Charge	Q _{gd}			42		
Gate Resistance	R_g	f = 1 MHz	0.4	1.7	3.4	Ω
Turn-On Delay Time	t _{d(on)}			25	50	
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1 Ω		16	30	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		130	220	
Fall Time	t _f			38	70	no
Turn-On Delay Time	t _{d(on)}			130	220	ns
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 1 \Omega$		120	200	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		100	180	
Fall Time	t _f			55	100	
Drain-Source Body Diode Characterist	ics					
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			- 60	۸
Pulse Diode Forward Current	I _{SM}				- 100	Α
Body Diode Voltage	V_{SD}	I _S = - 5 A, V _{GS} = 0 V		- 0.71	- 1.1	V
Body Diode Reverse Recovery Time	t _{rr}			42	80	ns
Body Diode Reverse Recovery Charge	Q _{rr}	10 A dl/dt 100 A/vo T 05 °C		36	72	nC
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$		18		
Reverse Recovery Rise Time	t _b			24		ns

Notes:

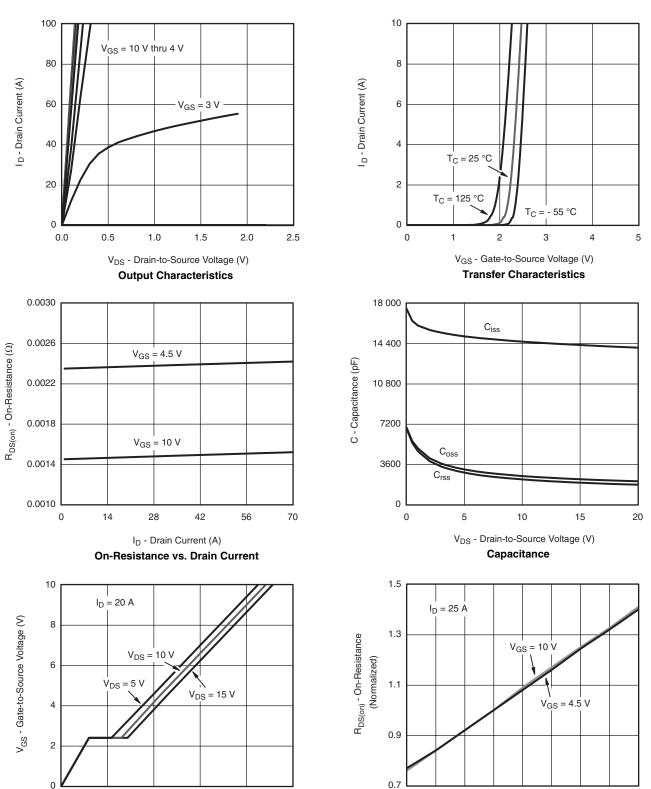
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



- 25

- 50

0

25

50

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

75

100

0

60

120

Q_g - Total Gate Charge (nC)

Gate Charge

180

240

300

125

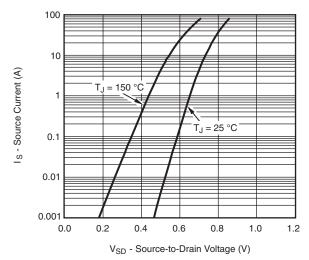
150

Si7141DP

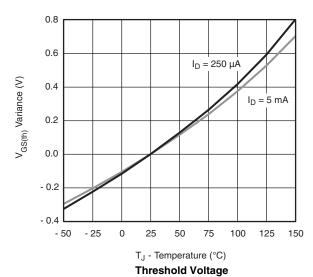
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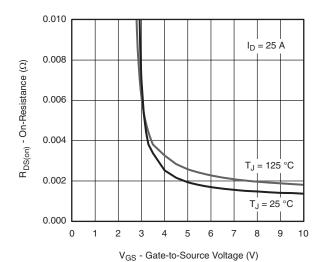
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

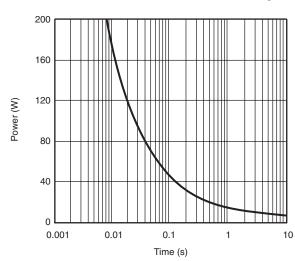


Source-Drain Diode Forward Voltage

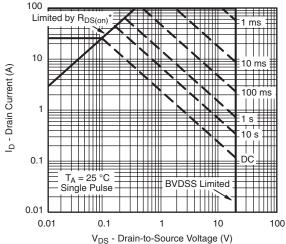




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



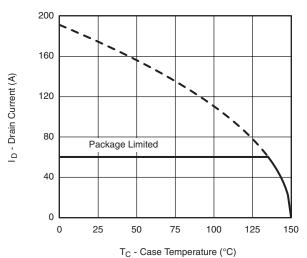
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area

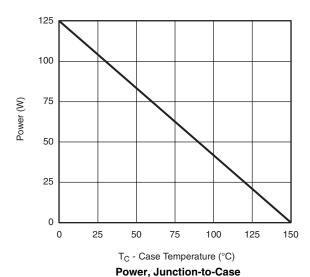


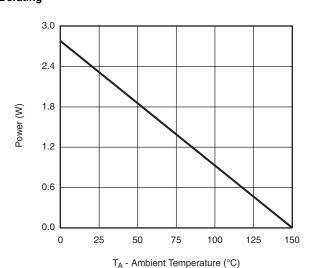
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





Power Derating, Junction-to-Ambient

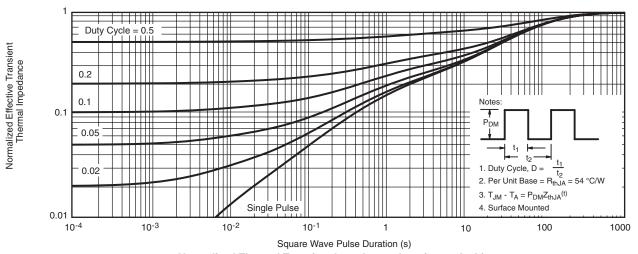
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si7141DP

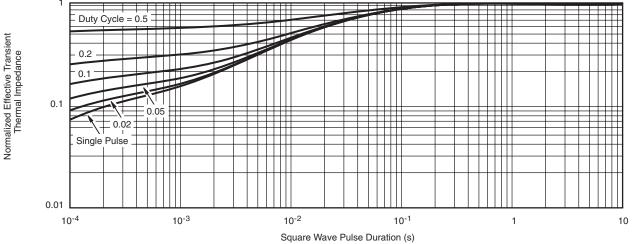
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?65596.



DWG: 5881

PowerPAK® SO-8, (Single/Dual)



	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4	0.57 typ.			0.0225 typ.			
D5		3.98 typ.		0.157 typ.			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2 (for AL product)	3.30	3.48	3.66	0.130	0.137	0.144	
E2 (for other product)	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4 (for AL product)		0.58 typ.		0.023 typ.			
E4 (for other product)		0.75 typ.		0.030 typ.			
е	1.27 BSC			0.050 BSC			
K (for AL product)		1.45 typ.		0.057 typ.			
K (for other product)	1.27 typ.			0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			

Revison: 20-May-13 Document Number: 71655



RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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